

Parameter	Symbol	Rating	Units	
Load Voltage	VL	20	V	
Load Current	ΙL	1.7	Α	
On-Resistance	Ron	0.5	Ω	
I/O Breakdown Voltage	V/IO	2500	Vrms	





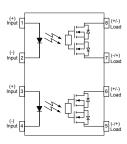








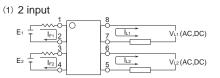
SOP-8

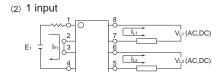


1,3. LED Anode

2,4. LED Cathode 5,6. Drain (MOS FET)

7,8. Drain (MOS FET)





# APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power.

While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

## **Applications**

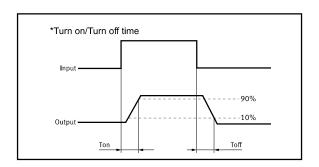
These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

#### **TPYES**

Catagoni	Outp	out Rating	Doolsono	Part No.	Packing Quantity	
Category	Load Voltage	Load Current	Package	Part No.		
AC/DC	20V	1.7A	SOP-8	APW211G1S	2000pcs /reel	





## Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Va <b>l</b> ue	Units	Note
	Continuous LED Current	lF	50	mA	
Input	Peak LED Current	Ігр	1000	mA	f=100Hz, duty=1%
·	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	P <sub>In</sub>	75	mW	
Output	Load Voltage	V∟	20	V(AC peak or DC)	
	Load Current	l.	1.7	Α	
	Peak Load Current	Peak	3.5	Α	300µs(1 pulse)
	Output Power Dissipation	Pout	1.8	W	
Total Power	Dissipation	Р⊤	2	W	
I/O Breakdov	vn Vo <b>l</b> tage	V <sub>I/O</sub>	2500	Vrms	RH=60%, 1min
Operating Te	emperature	Торг	-40 to 85	°C	
Storage Tem	perature	T <sub>stg</sub>	-40 to 100	°C	
Pin Soldering	g Temperature	T <sub>sol</sub>	260	°C	10 sec max.

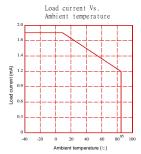
## Electrical Characteristics (Ta = 25°C)

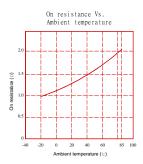
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	VF		1.2	1.4	V	I⊧=10mA
	Operation LED Current	Fon		0.5	2.0	mA	
	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V <sub>Foff</sub>	0.5			V	
Output							I⊧=5mA,I∟=100mA,
	On-Resistance	Ron		0.5	1.2	Ω	Time to flow is within 1 sec.
	Off-State Leakage	Leak	0.01	0.02	0.1	uA	V∟=Rating
	Current	- Louit	0.01	0.02	0.1	G, 1	vi raing
	Output Capacitance	Cout		185		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton			1.5	ms	I⊧=5mA, I∟=100mA,
sion	Turn-Off Time	Toff			0.1	ms	
Counted	I/O Isolation Resistance	R <sub>I/O</sub>	10 <sup>10</sup>			Ω	DC500V
Coupled	I/O Capacitance	C <sub>I/O</sub>		0.8	1.5	pF	f=1MHz

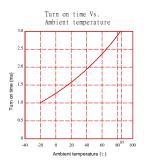
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

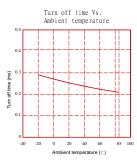


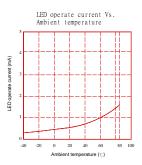
## **Engineering Data**

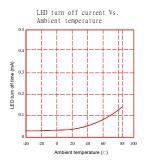


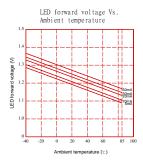


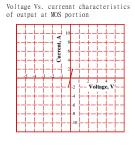


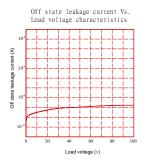


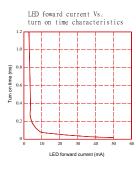


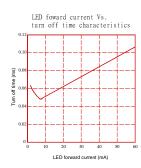


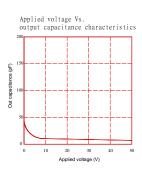








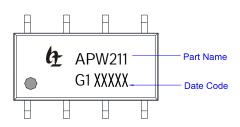






# Dimensions and SOP-8 Package Unit: mm

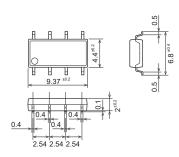
## Marking



#### Lable



## Surface mount terminal type

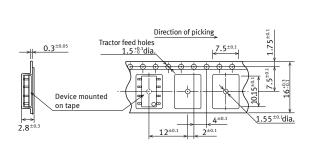


# Recommended mounting pad (Top view)

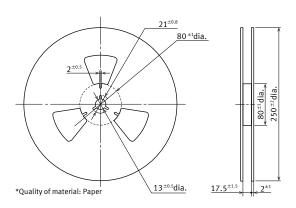


#### Tape dimensions (tape reel)

Tape dimensions (Unit: mm)



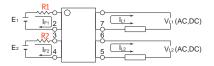
#### Dimensions of paper tape reel (Unit: mm)





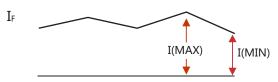
## **Using Methods**

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)				
3.3V	300 Ω				
5.0V	600 Ω				
12V	1.9KΩ				
24V	4.1K Ω				

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



#### **Recommended Operating Conditions**

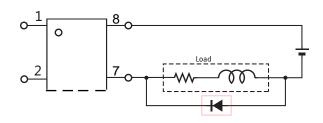
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

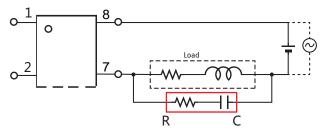
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

#### **Protection Circuit**

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



## **RESTRICTIONS ON PRODUCT USE**

APSEMI Co. and its subsidiaries and affiliates (collectively "APSEMI") reserve the right to make changes to all information contained in this document relating to hardware, software, and systems (collectively "Products").

No information in this document may be reproduced without the prior written permission of APSEMI. Even with APSEMI's written permission, this document may only be reproduced if it is guaranteed to be unaltered or missing.

APSEMI assumes no responsibility for unintended uses of the product:

Unintended uses include, but are not limited to, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, automobiles, trains, ships, and other transportation equipment, traffic signaling equipment, equipment used for the control of combustion or explosions, safety devices, elevators and escalators, equipment used in electrical power-related applications, and equipment used in financial-related applications.

APSEMI assumes no responsibility for the product if you use it for any purpose other than the specific purpose described in this document.

- The information contained herein is provided only as a guide for the use of the product.
   APSEMI assumes no responsibility for infringement of third party patents or any other intellectual property rights that may result from the use of the product. This document does not grant any license, express or implied, estoppel or otherwise, to any intellectual property.
- GaAs (Gallium Arsenide) is used in products and is harmful to humans. Inadvertent ingestion or absorption of GaAs can harm the human body, so handle the product with care and do not break, cut, crush, grind, chemically dissolve, or otherwise expose GaAs in the product.
- •Please be aware of environmental issues and use products in compliance with all applicable laws and regulations governing the inclusion or use of controlled substances, including but not limited to the EU RoHS Directive. APSEMI assumes no responsibility for damages or losses resulting from non-compliance with applicable laws and regulations.